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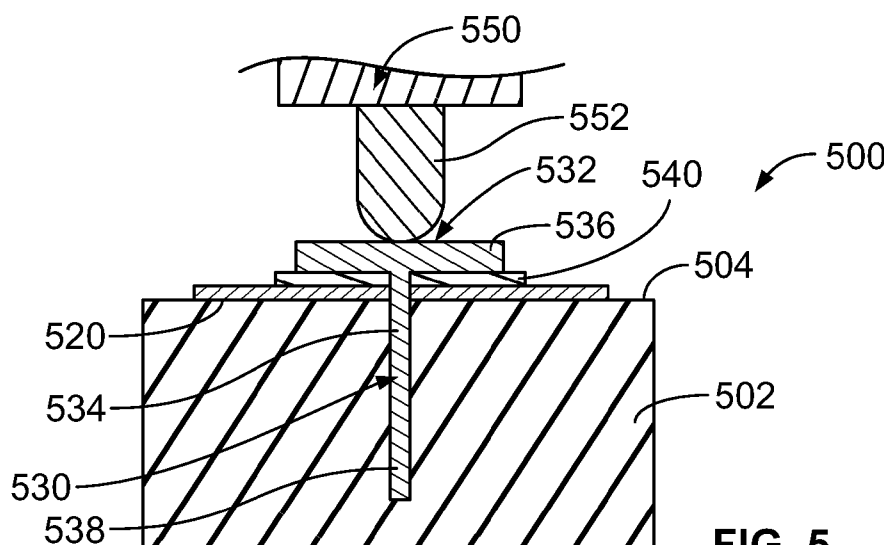


FIG. 5

(57) **Abstract:** An electronic device (500) includes a dielectric substrate (502) having a first surface (504), a conductive circuit (520) deposited on the first surface and having a printed conductive ink trace (520) on the first surface, and a conductive interposer (530) mechanically coupled to the substrate. The conductive interposer is electrically coupled to the conductive circuit. The conductive interposer has a separable contact interface (532) configured to be mechanically and electrically connected to a removable contact. Optionally, the conductive interposer may include a main body (534) and a flexible element (540) extending between the main body and the conductive circuit. The flexible element electrically connects the conductive circuit with the main body.